

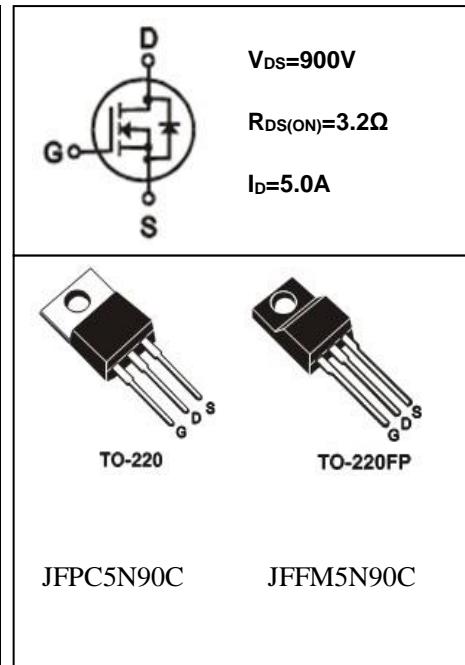
## N-沟道功率 MOS 管/ N-CHANNEL POWER MOSFET

- 特点：导通电阻低 开关速度快 输入阻抗高 符合RoHS规范
- FEATURES: ■LOW ON-RESISTANCE ■FAST SWITCHING ■HIGH INPUT RESISTANCE  
■RoHS COMPLIANT
- 应用：电子镇流器 电子变压器 开关电源
- APPLICATION: ■ELECTRONIC BALLAST ■ELECTRONIC TRANSFORMER ■SWITCH MODE POWER SUPPLY

### ●最大额定值 (Tc=25°C)

#### ●Absolute Maximum Ratings (Tc=25°C) TO-220/220F

参数 PARAMETER	符号 SYMBOL	额定值 VALUE	单位 UNIT
漏-源电压 Drain-source Voltage	V <sub>DS</sub>	900	V
栅-源电压 gate-source Voltage	V <sub>GS</sub>	±30	V
漏极电流 Continuous Drain Current TC=25°C	I <sub>D</sub>	5.0*	A
漏极电流 Continuous Drain Current TC=100°C	I <sub>D</sub>	2.5*	A
最大脉冲电流 Drain Current -Pulsed ①	I <sub>DM</sub>	16*	A
耗散功率 Power Dissipation	P <sub>tot</sub>	TO-220:106 TO-220F:36	W
最高结温 Junction Temperature	T <sub>j</sub>	150	°C
存储温度 Storage Temperature	T <sub>STG</sub>	-55-150	°C
单脉冲雪崩能量 Single Pulse Avalanche Energy ②	E <sub>AS</sub>	260	mJ



\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature

### ●电特性 (Tc=25°C)

#### ●Electronic Characteristics (Tc=25°C)

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
漏-源击穿电压 Drain-source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	900			V
击穿电压温度系数 Breakdown Voltage Temperature Coefficient	Δ BV <sub>DSS</sub> / Δ T <sub>j</sub>	I <sub>D</sub> =250μA, Referenced to 25°C		0.6		V/°C
栅极开启电压 Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA	3.0		5.0	V
漏-源漏电流 Drain-source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =900V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C			1	μA
		V <sub>DS</sub> =720V, V <sub>GS</sub> =0V, T <sub>j</sub> =125°C			10	μA
跨导 Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =40V, I <sub>D</sub> =2.5A ③		2.5		S

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
栅极漏电流 Gate-body Leakage Current ( $V_{DS} = 0$ )	$I_{GSS}$	$V_{GS} = \pm 30V$			$\pm 100$	nA
漏-源导通电阻 Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 2.5A$ ③		2.80	3.2	$\Omega$
输入电容 Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 25V$ $F = 1.0MHz$		850		pF
输出电容 Output Capacitance	$C_{oss}$			56		
反向传输电容 Reverse transfer Capacitance	$C_{rss}$			14		
关断延迟 Turn -Off Delay Time	$T_{d(off)}$	$V_{DD} = 450V, I_D = 5.0A$ $R_G = 25\Omega$ ③		25		ns
栅极电荷 Total Gate Charge	$Q_g$	$I_D = 5.0A, V_{DS} = 720V$ $V_{GS} = 10V$ ③		17.4		nC
栅源电荷 Gate-to-Source Charge	$Q_{gs}$			4.5		nC
栅漏电荷 Gate-to-Drain Charge	$Q_{gd}$			5.4		nC
二极管正向电流 Continuous Diode Forward Current	$I_s$				5.0	A
二极管正向压降 Diode Forward Voltage	$V_{SD}$	$T_j = 25^\circ C, I_s = 5.0A$ $V_{GS} = 0V$ ③			1.4	V
反向恢复时间 Reverse Recovery Time	$t_{rr}$	$T_j = 25^\circ C, I_f = 5.0A$ $di/dt = 100A/\mu s$ ③		250		ns
反向恢复电荷 Reverse Recovery Charge	$Q_{rr}$			1.5		$\mu C$

### ●热特性

### ●Thermal Characteristics

参数 PARAMETER	符号 SYMBOL	最大值 MAX		单位 UNIT
		TO-220	TO-220FP	
热阻结-壳 Thermal Resistance Junction-case	$R_{thJC}$	1.18	3.47	$^\circ C/W$
热阻结-环境 Thermal Resistance Junction-ambient	$R_{thJA}$	62.5	62.5	$^\circ C/W$

### 注释(Notes):

① 脉冲宽度：以最高结温为限制

Repetitive rating: Pulse width limited by maximum junction temperature

② 初始结温= $25^\circ C$ ,  $V_{DD} = 50V$ ,  $L = 30mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 3.0A$

Starting  $T_j = 25^\circ C$ ,  $V_{DD} = 50V$ ,  $L = 30mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 3.0A$

③ 脉冲测试：脉冲宽度 $\leq 300\mu s$ ，占空比 $\leq 2\%$

Pulse Test : Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$

## ● 特性曲线

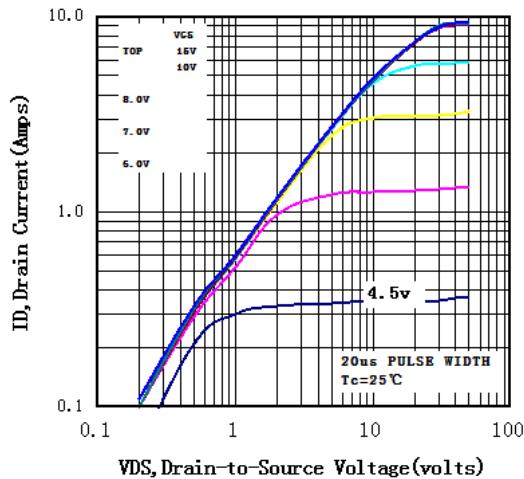


图 1 输出特性曲线,  $T_c=25^\circ\text{C}$

Fig1 Typical Output Characteristics,  $T_c=25^\circ\text{C}$

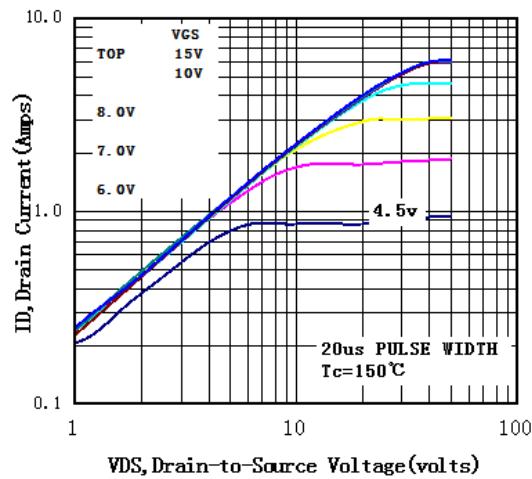


图 2 输出特性曲线,  $T_c=150^\circ\text{C}$

Fig2 Typical Output Characteristics,  $T_c=150^\circ\text{C}$

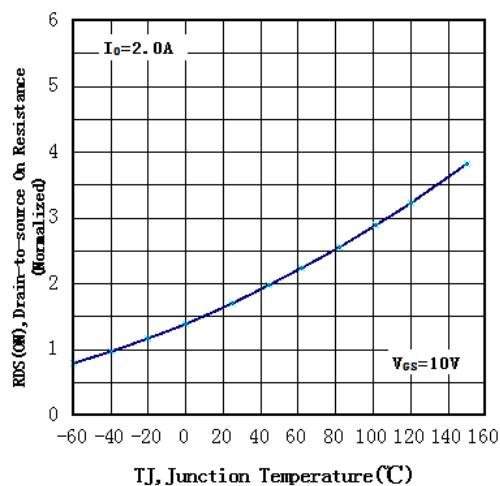


图 3 归一化导通电阻与温度曲线

Fig3 Normalized Resistance Vs.Temperature

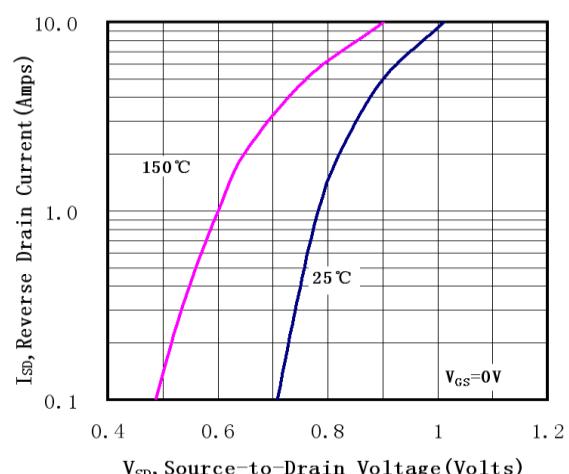


图 4 二极管正向电压曲线

Fig4 Typical Source-Drain Diode Forward Voltage

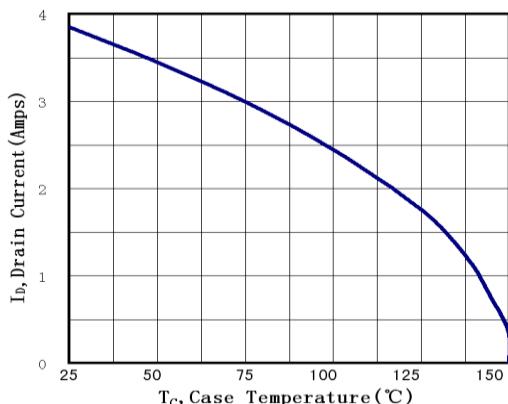


图 5 最大漏极电流与壳温曲线

Fig5 Maximum Drain Current Vs.Case Temperature

● 特性曲线

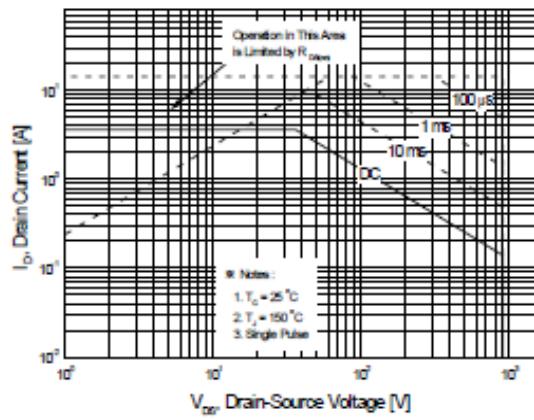


图 6-1 最大安全工作区曲线(TO-220)

Fig6-1 Maximum Safe Operating Area

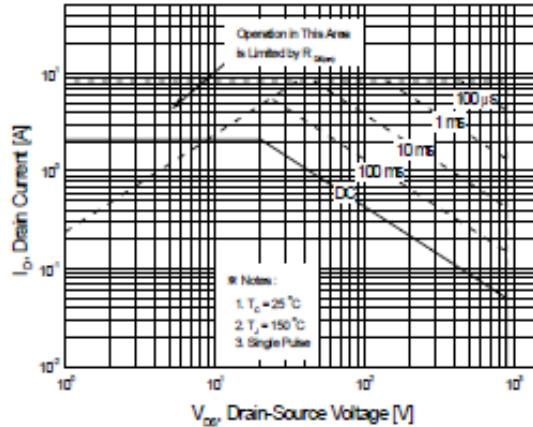


图 6-2 最大安全工作区曲线(TO-220F)

Fig6-2 Maximum Safe Operating Area